DWG. NO.

CR5813-OS

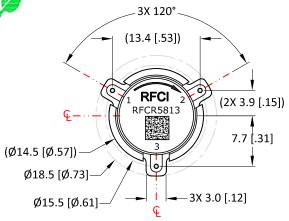
REVISIONS

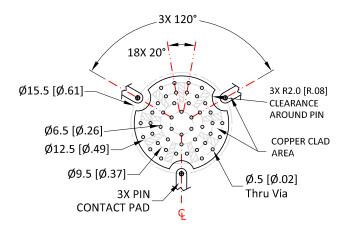
SHT REV
1 A

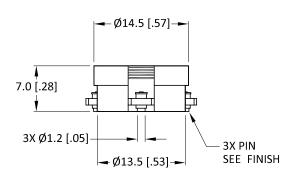
THIS DRAWING HAS BEEN GENERATED BY A CAD SYSTEM. CHANGES SHALL ONLY BE INCORPORATED AS DIRECTED BY THE DESIGN ACTIVITY.

	REVISIONS			
REV.	DESCRIPTION	ECO	DATE	APPROVED
Α	INITIAL RELEASE	I.R.	06/25/15	P.T









SolderMask Pattern

Recommended Footprint Copper-Solder Mask Pattern

The Land Pattern should be with good thermal conductivity

Finish:

- 1. Housing: Silver plated
- 2. Pin: Gold plated
- 3. Coplanarity specification: 0.10 [.004] MAX.

Specifications

Parameter	Minimum	Typical	Maximum
Frequency Range (MHz)	2550		2650
Insertion Loss (dB)		< .25	.30
Isolation (dB)	20	> 23	
Return Loss (dB)	20	> 23	

Power & Temperature Ratings

Parameter	Maximum		
Forward PWR Peak/AVG	500/100 Watts		
Reverse Power CW	80 Watts		
Operating Temperature	-40 to +85° C		
Storage Temperature	-50 to +125° C		

NOTES:

- 1. Typical Values Represent Performance @ +23 °C.
- 2. S-Parameters to be measured by connecting Port 1 and 2 to VNA, and Port 3 to Load with return loss 30dB or higher

CW SMD CIRCULATOR MODEL: RFCR5813

